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Thermoelectric properties of $Mg_2(Ge, Sn)$: Model and optimization of ZT

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We report an investigation of the thermoelectric properties of $Mg_2Ge_{1-x}Sn_x$ solid solution with x = 0.5 using models based on first-principles calculations and experimental data. The model gives transport properties including the figure of merit ZT as functions of carrier concentration and temperature. The model for *n*-type predicts high ZT at optimized doping, and suggests that the ZT value can exceed 2 at T = 1000 K.

I. INTRODUCTION

Themoelectric (TE) materials are of interest due to applications in power generation and refrigeration. Applications such as waste heat recovery, e.g., in automobiles, will require practical materials that are both amenable to manufacturing and have high performance in the 500 K - 1000 K temperature range¹⁻³. The performance of a TE material is characterized by a dimensionless figure of merit $ZT = \sigma S^2 T / (\kappa_l + \kappa_e)$, and σ , S, T, κ_l and κ_e are electrical conductivity, Seebeck coefficient, temperature, lattice and electronic contributions to the thermal conductivity, respectively. Much effort has been focused on improving and optimizing ZT by increasing the power factor $S^2\sigma$ or reducing the thermal conductivity⁴⁻⁶. State-of-the-art TE materials such as the commercialized (Bi,Sb)₂Te₃ derived alloys^{7,8}, PbTe and related alloys⁹⁻¹¹, some skutterudite alloys^{12,13} have ZT > 1.0 in a intermediate operating temperature range (500 K \sim 1000 K). For applications, practical materials that have environmentally acceptable composition are important.

The solid solutions of Mg₂X (X = Si, Ge and Sn) are promising candidates for mid-temperature range energy conversion^{14–31}. Most of the work has been focused on the Mg₂Si-Mg₂Sn alloys. The ZT of *n*-type compositions are significantly higher than those of *p*-type. In particular, the ZT values of *n*-type Mg₂Si_{0.5}Sn_{0.5} systems can reach 1.5^{24} at 600 K by varying x value. Recently, Liu and co-workers²⁹ have successfully synthesised Mg₂Sn_{0.75}Ge_{0.25} that with *n*-type ZT value of 1.4 at 450 °C. Comparing to *n*-type, the reported *p*-type Mg₂X solid solutions have much lower ZT values, with about 0.35 for Mg₂Si-Mg₂Sn alloy³², 0.36 for Mg₂Si-Mg₂Ge alloy¹⁹ and up to 0.38 for Mg₂Ge-Mg₂Sn²⁸.

Here we address the thermoelectric properties of Mg₂Ge-Mg₂Sn solid solution, with a typical composition of Mg₂Ge_{0.5}Sn_{0.5}, from a combination of first-principles calculations and analysis of existing experimental data. By optimizing the ZT with respect to the doping concentrations at different temperatures, we find a peak ZT value of 2.25 for *n*-type and 0.4 for *p*-type at 1000 K and reasonable high doping concentrations (~ 10²⁰ cm⁻³). Thus the material can be further improved by tuning the carrier concentrations.

II. COMPUTATIONAL APPROACH

The semiquantitative models for both n- and ptype $Mg_2Ge_{0.5}Sn_{0.5}$ are based on existing experimental data and first-principles calculations. Specifically, due to the lack of the data on $Mg_2Ge_{0.5}Sn_{0.5}$, we used data for $Mg_2Ge_{0.4}Sn_{0.6}$ to model our *p*-type ZT and $Mg_2Ge_{0.25}Sn_{0.75}$ for *n*-type case. The construction of the model is similar to a model previously made for $PbSe^{33}$, which predicted that ZT could significantly exceed the known values, a fact that was later confirmed experimentally³⁴. We also investigated a higher Sn composition, $Mg_2Ge_{0.25}Sn_{0.75}$ in order to study the effects of composition dependent band structure change. The theoretical transport functions and coefficients were obtained using Boltzmann theory within the constant scattering time approximation (CSTA) as implemented in the BoltzTraP code³⁵. This CSTA approach has been successfully applied in calculating the Seebeck coefficient for various TE materials $^{36-39}$. It assumes the energy dependence of the scattering rate is negligible compared with the energy dependence of the electronic structure.

The band structure calculations were performed using the linearized augmented plane-wave (LAPW) method⁴⁰ as implemented in the WIEN2K $code^{41}$. The crystal structure of $Mg_2Ge_{0.5}Sn_{0.5}$ solid solution was modeled by doubling the original cubic structure to a P4/mmmtetragonal structure (formula, Mg_4GeSn) with Ge at (0,0,0), Sn at (1/2,1/2,1/2) and Mg at (0,1/2,z), as shown in Fig. 1. The experimental lattice constants of $Mg_2Ge_{0.5}Sn_{0.5}^{28}$ were used and the atomic coordinates were relaxed within the Perdew, Burke and Ernzerhof (PBE) type functional of the generalized gradient approximation $(GGA)^{42}$. We also did calculations for other supercells. This included a larger 24-atom cell with lower symmetry. However we did not find significant changes. The LAPW sphere radii were 2.5 bohr for Mg, Ge and Sn and the cut-off parameter for the basis was $R_{min}K_{max} = 8$. We used a k-point sampling of $5 \times 5 \times 3$ for the total energy calculations and a k-mesh of $14 \times 14 \times 10$ for the density of states. A much denser k-mesh of $30 \times 30 \times 21$ was used for the calculations of isosurfaces and transport properties. The modified Becke-Johnson (mBJ) potential⁴³ was used to obtain the electronic structures. This potential has been proved to be reasonable for the calculations of semiconductor and in-



FIG. 1. Crystal structures of $Mg_2Ge_{1-x}Sn_x$ (a) and doubled cell (b) with formula Mg_4GeSn . Solid line indicates the unit cell.



FIG. 2. Calculated band structure of $Mg_2Ge_{0.5}Sn_{0.5}$. Energy zero is set at the valence band maximum.

sulator systems and typically gives substantial improved band $gaps^{43-45}$. Spin-orbit coupling was included in all the calculations except structure relaxations.

III. RESULTS AND DISCUSSIONS

The calculated band structure using the mBJ potential is shown in Fig. 2. It has a direct band gap of 0.23 eV at the Γ point. This value is 0.045 eV using PBE functional. The band gap values of pure binary Mg₂Ge and Mg₂Sn were reported to be 0.74 eV and 0.35 eV⁴⁶ and our calculated results with mBJ are 0.51 eV and 0.10 eV, respectively. Moreover, it has been demonstrated that the energy gap of Mg₂Ge_{1-x}Sn_x decreases as x increases²⁸. Therefore the band gap is improved with the mBJ potential but still underestimate experiment as also seen in Mg₂Si-Mg₂Sn compounds⁴⁷. This may lead to a re-



FIG. 3. Total and projected density of states of $Mg_2Ge_{0.5}Sn_{0.5}$ with (a) showing the comparison of two different crystal structures and (b) the projected density of states of the structure used in this study. Density of states are shown per $Mg_2Ge_{0.5}Sn_{0.5}$ formula unit (f.u.).



FIG. 4. Calculated isoenergy surfaces of $\rm Mg_2Ge_{0.5}Sn_{0.5}$ near VBM and CBM.

duced ZT at high temperature due to overestimating the bipolar contribution, especially for *p*-type. The composition dependent band convergence is seen in Mg₂Si_{*x*}Sn_{1-*x*} alloys^{26,48–50}. The nearness of the conduction bands affects the performance, but because kT is e.g. ~ 0.07 eV at 800 K, the multiple nearby bands are important but exact convergence is not so crucial, which reduces composition dependence.

The electronic density of states are presented in Fig. 3. We found similar density of states especially near both the valence band edge and conduction band edge, as shown in Fig. 3 (a) for the different supercells. This supports the use of super cell as chosen and indicates the reliability of our following electronic structure dependent properties calculations. The projected electronic density of states are also depicted in Fig. 3 (b). As seen, the valence band is mainly dominated by anion p states and cation s and p states. A clear overlap between Mg 3s and

Ge 4p/Sn 5p can be seen at -4 eV below the valence band maximum (VBM) indicating the hybridization between Mg and Ge/Sn. The conduction band mainly consists of s and p empty states of Mg. Figure 4 shows the constant energy surfaces at 0.3 eV below and above the VBM and conduction band minimum (CBM), respectively. Both pand n type show complex corrugated isosurfaces, much different from simple spheres. Such complex shapes are generally beneficial for TE performance 51,52. Moreover, for *n*-type, in addition to the main surface around Γ , one observes four additional electron surfaces at the zone boundary M point starting close to the gap. These Mpoint carriers can participate in transport along with the two bands at Γ . Taking Γ and M together the *n*-type has a high number of pocket available for transport compared to p-type (note that T = 1000 K corresponds to $kT \sim 0.1$ eV).

The thermopower plays a central role in the performance of TE materials and can be directly calculated from the electronic structure obtained within the framework of density functional theory. By using of the Wiedemann-Franz relation where the electronic part of the thermal conductivity is expressed as $\kappa_e = L\sigma T$, the figure of merit ZT can be further reconstructed as $ZT = rS^2/L$. Here $r = \kappa_e/(\kappa_e + \kappa_l)$ and L = $2.45 \times 10^{-8} W\Omega/K^2$ is the standard Lorenz number. The fact that $r \leq 1$ implies the upper bound of ZT is limited by the thermopower. For the ZT larger than unity, the thermopower is usually higher than 200 μ V/K. The calculated result is shown in Fig. 5. There is a clear bipolar suppression for both p- and n-type at high temperatures and low carrier concentrations. One effect of the bipolar effects seen especially for p-type will be an increase in L, which will lead to higher thermal conductivity and lower ZT. The bipolar effect increases with T but decreases with carrier concentrations. High thermopowers (> 200) $\mu V/K$) are obtained even at high temperatures (~ 1000 K) with reasonable carrier concentrations ($\sim 10^{20} \text{ cm}^{-3}$) for both n- and p-type. Clearly, optimization of carrier concentration which is crucial for any thermoelectric will be particularly important for any x and operating T in $Mg_2(Ge,Sn)$ due to the bipolar effect.

Within the CSTA, the electrical conductivity is given as $\sigma = (\sigma/\tau) \times \tau$. It is possible to calculate σ/τ directly from electronic structure as a function of carrier concentration and temperature. But one can not solve for σ without the knowledge of τ , which is the inverse of the scattering rate. In a typical electron-phonon regime, τ is proportional to 1/T and decreases with carrier concentration and we take a standard form with $\tau \propto n^{-1/3}$.

In order to model the behavior of τ , the experimental data was used. Specifically for p type Mg₂Ge_{0.5}Sn_{0.5}, we used the data from Jiang and co-workers²⁸ who synthesised the Mg₂Ge_{0.4}Sn_{0.6} solid solution and doped with Ag. We choose the data set at a specific temperature of 400 K. The reported thermopower was about 203 μ V/K at this temperature. The corresponding doping level can be obtained by comparing with the cal-



FIG. 5. Calculated S(T, n/p) for both *n*- and *p*-type Mg₂Ge_{0.5}Sn_{0.5}. Solid horizontal line at 200 μ V/K represents the limitation of Seebeck coefficients for good TE materials.

culated S(T, n/p) in Fig. 5 as 4.48×10^{19} cm⁻³. The reported electrical conductivity was approximately 2.00 $\times 10^4$ S/m, which combined with the calculated σ/τ yields $\tau = 1.04 \times 10^{-5} T^{-1} p^{-1/3}$ with τ in s, T in K and p in cm⁻³. Similarly, we used the same strategy for the *n* type case. Recently, Liu and co-workers²⁹ reported a new Mg_2Sn -based *n* type TE material with formula of $Mg_2Ge_{0.25}Sn_{0.75}$ and the ZT value can be achieved to 1.4 at 450 °C. We conducted the same strategy to produce a second model by using the data at 400 K and the τ was fitted to be $\tau = 7.60 \times 10^{-5} T^{-1} n^{-1/3}$. Note that the corresponding doping level in taking the n type data is calculated to be 5.05×10^{19} cm⁻³, which is much lower than the measured one $(3 \times 10^{20} \text{ cm}^{-3})$. Therefore, we did a comparison calculation by taking the experimental σ and doping concentration. Then we find different $\tau = 3.00 \times 10^{-5} T^{-1} n^{-1/3}$. This other $\tau (\tau')$ was only used in the model for the final ZT as comparison and our following related results are based on the first τ . As mentioned, the σ can be calculated as $\sigma = (\sigma/\tau) \times \tau$, which is shown in Fig. 6. It is noted that the magnitude of σ is ten times larger for n type compared with p type. But the overall trend is similar in both cases. Similarly, for n type $Mg_2Ge_{0.25}Sn_{0.75}$, we obtained the $\tau = 3.94 \times 10^{-5} T^{-1} n^{-1/3}.$

The corresponding power factor is plotted in Fig. 7 for Mg₂Ge_{0.5}Sn_{0.5}. For *n* type, it is seen that the power factor increases with temperature and doping level until reaching the maximum value at 4.5×10^{20} cm⁻³, with a peak value of 0.012 W/mK². This value is about twice the power factor found in Liu's experiment with Mg₂Ge_{0.25}Sn_{0.75} samples and higher but comparable to other calculated results at corresponding temperatures for Mg₂Si_{1-x}Sn_x solid solutions^{17,26}. On the other hand, the *p* type power factor shows weaker *T* dependent with the peak shifting to higher carrier concentrations with increasing *T*, e.g., from $p = 4 \times 10^{19}$ cm⁻³ at 400 K to $p = 4 \times 10^{20}$ cm⁻³ at 1000 K with peak value of 0.0015



FIG. 6. Calculated electrical conductivity for both n- and p-type Mg₂Ge_{0.5}Sn_{0.5}.

 W/mK^2 . The results are in accord with Jiang's data (e.g., 0.0011 W/mK^2 at 650 K for Mg₂Ge_{0.4}Sn_{0.6}).

Optimization of ZT also requires the knowledge of the thermal conductivity which consists of the contributions from the lattice and the electronic parts and sometimes including the bipolar effects^{24,29}. As mentioned, the electronic part can be directly calculated using the Wiedemann-Franz relation from $\kappa_e = L\sigma T$. The lattice thermal conductivity κ_l typically goes as 1/T until high temperatures where it becomes saturated and reaches the limit of thermal conductivity⁵³. κ_l is also generally the least dependent on doping. Therefore we can make an estimation of the thermal conductivity as $\kappa = A/T + L\sigma T$. With the calculated σ , the constant A can be determined using the experimental data. Here we chose Jiang's data at low temperature range (300 K - 500 K) for fitting the ptype κ_l . For *n* type, we adopted the same lattice part for $Mg_2Ge_{0.5}Sn_{0.5}$ but with Liu's data for $Mg_2Ge_{0.25}Sn_{0.75}$. It is noted that the electronic contribution to the total thermal conductivity is substantial at high temperatures in Liu's data and this may lead to larger errors in the extracted lattice thermal conductivity. We use Jiang's data for the model. Using Liu's data leads to a very similar maximum ZT, less than 5% lower. Note that



FIG. 7. Calculated power factor for both n- (a) and p-type (b) Mg₂Ge_{0.5}Sn_{0.5}.

the potential bipolar effects, which are evident at high temperatures and low doping levels are included in the calculations of σ_e . In order to overcome the potential inaccuracy from the strong bipolar effects in the p type case, which is also seen in the experiments²⁸, the calculated L was used. As shown in Fig. 8, L is clearly a function of doping level and temperature as also observed in analogous compound Mg₂Si_{1-x}Sn_x³⁰. For n type case, the constant L was used. This is because the p-type mobility is significantly lower than n-type. The results is that bipolar effects are low for n-type, while calculation of L would require assuming equal τ .

In any case, we are able to model ZT as a function of temperature and carrier concentration. Results are given in Figs. 9 and 10 for Mg₂Ge_{0.5}Sn_{0.5} and Fig. 11 for *n* type Mg₂Ge_{0.25}Sn_{0.75}. It is clearly shown that *n* type material has higher ZT value compared with *p* type. In particular, the maximum value of ZT increases with increasing doping levels and at elevated temperatures. A peak ZT of 2.25 (2.35 if Liu's data is used for κ_l)for *n* type Mg₂Ge_{0.5}Sn_{0.5} at 1000 K is found with a doping level of 9×10^{19} cm⁻³. This ZT value is higher comparing with Liu's experiment (1.4 at 450 °C). Our comparison calculation on *n* type Mg₂Ge_{0.25}Sn_{0.75} also exhibits high



FIG. 8. Calculated L_0 versus temperature and doping concentration for *p*-type Mg₂Ge_{0.5}Sn_{0.5}.

 $ZT \ (\sim 2.1)$, indicating the band structure difference at conduction band edge dos not have significant effects at high T. Figure 12 shows the optimized ZT from the τt introduced above. As seen the maximum ZT is about 1.7 at 1000 K. This difference might be viewed as an error bar on the model. However it is likely that the τ result is an underestimate of the ultimate ZT because the temperature dependence of the experimental data upon which it is based suggests the defect scattering is playing a role and could be improved. $Mg_2Ge_{0.5}Sn_{0.5}$ is expected to have larger band gaps with the addition of Ge comparing to $Mg_2Ge_{0.25}Sn_{0.75}$ even $Mg_2Ge_{0.4}Sn_{0.6}$. This suggests the possibility to extend the operating temperature of $Mg_2Ge_{0.5}Sn_{0.5}$ and higher ZT is achievable. On the other hand, the p type material is inferior to n type on the performance with maximum ZT value of 0.4 at 1000 K. Jiang and co-workers²⁸ reported ZT of 0.38 at 650 K for $Mg_2Ge_{0.4}Sn_{0.6}$ samples, which agree well with our calculated result at corresponding carrier concentration if composition difference is considered. High ZT values up to 1.4 at 900 K was seen in both experiments and theory calculations of n-type Mg₂(Si-Ge-Sn) pseudo-quaternary solid solutions 54,55. This results from very low thermal conductivity ($\sim 2 \text{ W/mK}$) due to multi-phase alloving. This value is lower than Liu's work ($\sim 3 \text{ W/mK}$) for $Mg_2Ge_{0.25}Sn_{0.75}$ which can achieve 1.4 ZT at 450 °C.

IV. SUMMARY AND CONCLUSIONS

In summary, we have investigated the electronic and the thermoelectric properties of the Mg₂Ge-Mg₂Sn solid solutions with a typical composition of Mg₂Ge_{0.5}Sn_{0.5}. A practical TE device requires both n and p type materials. Thus while the p-type ZT estimated here is not as impressive as n-type the fact that potential improvement can be achieved in Mg₂Ge_{0.5}Sn_{0.5} compared





FIG. 9. Calculated ZT versus T for both n- (a) and p-type (b) Mg₂Ge_{0.5}Sn_{0.5} using the model discussed in the text.

efforts to further optimizing the material.

The transport functions and related parameters are calculated using the combination of the existing experimental data and the first principles calculations. We find superior thermoelectric performance in n type material as is known from experimental measurements of Mg₂Ge-Mg₂Sn solid solutions. Importantly, we find high ZTvalue of 2.25 at 1000 K for n type and 0.4 for p type at the same temperature and similar doping range. In any case, our semiquantitative optimization of ZT with respect to carrier concentrations and temperatures offers a better understanding of this environmental friendly and promising thermoelectric material. The results imply that Mg₂(Ge,Sn) alloys can be further improved through additional optimization of the carrier concentration, and sample quality.

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FIG. 10. Calculated ZT versus doping concentration for both n- and p-type Mg₂Ge_{0.5}Sn_{0.5} using the model discussed in the text.



FIG. 11. Calculated ZT versus doping concentration for n type $\rm Mg_2Ge_{0.25}Sn_{0.75}.$



FIG. 12. Calculated ZT versus doping concentration for n type Mg₂Ge_{0.5}Sn_{0.5} using the fitted $\tau \prime$ (see text).

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